MOSFET – Small Signal, Complementary, SOT-963, 1.0 x 1.0 mm

20 V, 220 mA / -200 mA

Features

- Complementary MOSFET Device
- Offers a Low R_{DS(on)} Solution in the Ultra Small 1.0x1.0 mm Package
- 1.5 V Gate Voltage Rating
- Ultra Thin Profile (< 0.5 mm) Allows It to Fit Easily into Extremely Thin Environments such as Portable Electronics.
- This is a Pb–Free Device

Applications

- Load Switch with Level Shift
- Optimized for Power Management in Ultra Portable Equipment

MAXIMUM RATINGS (T_J = 25° C unless otherwise specified)

Para	Symbol	Value	Unit			
Drain-to-Source Voltag	V _{DSS}	20	V			
Gate-to-Source Voltag	Gate-to-Source Voltage					
N-Channel	Steady	$T_A = 25^{\circ}C$		220		
Continuous Drain Current (Note 1)	State	$T_A = 85^{\circ}C$		160		
	$t \le 5 s$	$T_A = 25^{\circ}C$		280		
P-Channel	Steady	$T_A = 25^{\circ}C$	I _D	-200	mA	
Continuous Drain Current (Note 1)	State	$T_A = 85^{\circ}C$		-140		
	t ≤ 5 s	$T_A = 25^{\circ}C$		-250		
Power Dissipation	Steady			125		
(Note 1)	State	$T_A = 25^{\circ}C$	PD		mW	
	t ≤ 5 s			200	1	
Pulsed Drain Current	N-Channel	t 10.00	1	800	mA	
	P-Channel	t _p = 10 μs	IDM	-600	mA	
Operating Junction and	Storage Tem	perature		-55 to	°C	
			T _{STG}	150		
Source Current (Body I	Diode) (Note 2	2)	۱ _S	200	mA	
Lead Temperature for S (1/8" from case for 1		oses	ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz. Cu.

2. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%

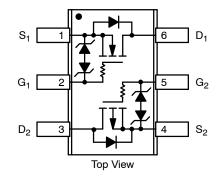


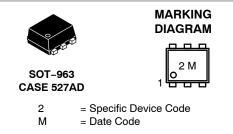
ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(on)} Max	I _D Max
	1.5 Ω @ 4.5 V	
N-Channel	2.0 Ω @ 2.5 V	
20 V	3.0 Ω @ 1.8 V	0.22 A
	4.5 Ω @ 1.5 V	
	5.0 Ω @ –4.5 V	
P-Channel	6.0 Ω @ –2.5 V	-0.2 A
20 V	7.0 Ω @ –1.8 V	-0.2 A
	10 Ω @ –1.5 V	

PINOUT: SOT-963





ORDERING INFORMATION

Device	Package	Shipping [†]
NTUD3169CZT5G	SOT-963 (Pb-Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient - Steady State, Minimum Pad (Note 3)	$R_{\theta JA}$	1000	°C/W
Junction-to-Ambient – t \leq 5 s (Note 3)		600	

3. Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz. Cu.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	N/P	Test Condition	on	Min	Тур	Max	Unit	
OFF CHARACTERISTICS		-							
Drain-to-Source Breakdown Voltage	M	Ν		I _D = 250 μA	20			V	
	V _{(BR)DSS}	Р	$V_{GS} = 0 V$	I _D = -250 μA	-20			V	
Zero Gate Voltage Drain Current		N		$T_J = 25^{\circ}C$			50		
				T _J = 85°C			200	~^	
		IDSS	Р		$T_J = 25^{\circ}C$			-50	nA
		P	P $V_{GS} = 0 V, V_{DS} = -5.0 V$	T _J = 85°C			-200		
Zero Gate Voltage Drain Current	1	Ν	V_{GS} = 0 V, V_{DS} = 16 V	T 05°C			100	~^	
	IDSS	I_{DSS} P $V_{GS} = 0 V, V_{DS} = -16 V$	T _J = 25°C			-100	nA		
Gate-to-Source Leakage Current	I	Ν					±100	~^	
	I _{GSS}	Р	V_{DS} = 0 V, V_{GS} =	±3.0 V			±100	nA	

ON CHARACTERISTICS (Note 4)

Gate Threshold Voltage		Ν	$V_{GS} = V_{DS}$	I _D = 250 μA	0.4		1.0	V
	V _{GS(TH)}	Р		I _D = -250 μA	-0.4		-1.0	
Drain-to-Source On Resistance		Ν	V _{GS} = 4.5 V, I _D = 1	100 mA		0.75	1.5	
		Р	V _{GS} = -4.5V, I _D = -	-100 mA		2.0	5.0	
		Ν	V _{GS} = 2.5 V, I _D =	50 mA		1.0	2.0	
		Р	$V_{GS} = -2.5V, I_D = -2.5V$	–50 mA		2.6	6.0	
	D	Ν	V _{GS} = 1.8 V, I _D =	20 mA		1.4	3.0	0
	R _{DS(on)}	Р	$V_{GS} = -1.8V, I_D = -1.8V$	–20 mA		3.4	7.0	Ω
		Ν	V _{GS} = 1.5 V, I _D =	10 mA		1.8	4.5	
		Р	V_{GS} = -1.5 V, I _D =	–10 mA		4.0	10	
		Ν	V_{GS} = 1.2 V, I _D =	1.0 mA		2.8		
		Р	V_{GS} = -1.2 V, I _D = -	–1.0 mA		6.0		
Forward Transconductance	_	Ν	V _{DS} = 5.0 V, I _D = 1	125 mA		0.48		0
	9fs	Р	V _{DS} = -5.0 V, I _D = -	-125 mA		0.35		S
Source-Drain Diode Voltage	V _{SD}	Ν	V_{GS} = 0 V, I _S = 10 mA	$T_J = 25^{\circ}C$		0.6	1.0	V
		Р	V_{GS} = 0 V, I_{S} = -10 mA			-0.6	-1.0	

CAPACITANCES

Input Capacitance	C _{ISS}			12.5	
Output Capacitance	C _{OSS}	Ν	f = 1 MHz, V _{GS} = 0 V V _{DS} = 15 V	3.6	
Reverse Transfer Capacitance	C _{RSS}	1		2.6	- 5
Input Capacitance	C _{ISS}			13.5	pF
Output Capacitance	C _{OSS}	Р	f = 1 MHz, V _{GS} = 0 V V _{DS} = -15 V	3.8	
Reverse Transfer Capacitance	C _{RSS}	1		2.0	

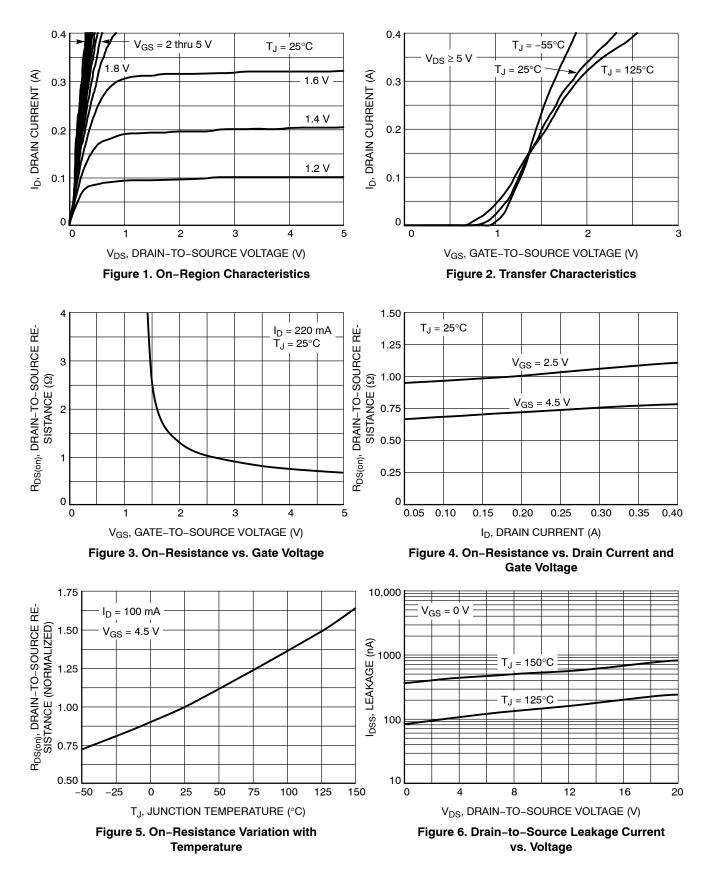
4. Switching characteristics are independent of operating junction temperatures

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

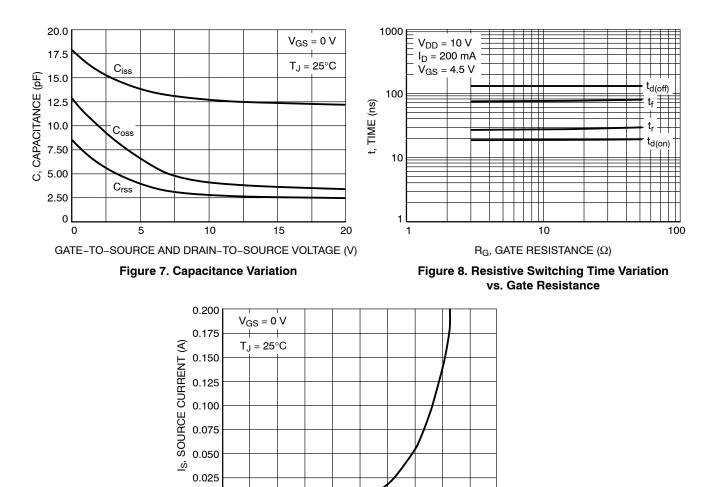
Parameter	Symbol	N/P	Test Condition	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS, \	GS = 4.5 V (Not	e 4)					
Turn-On Delay Time	t _{d(ON)}				16.5		
Rise Time	t _r	N	V_{GS} = 4.5 V, V_{DD} = 10 V, I_{D} = 200 mA, R_{G} = 2.0 Ω		25.5		
Turn-Off Delay Time	t _{d(OFF)}	IN			142		
Fall Time	t _f				80		
Turn-On Delay Time	t _{d(ON)}				26		ns
Rise Time	t _r	Р	V _{GS} = -4.5 V, V _{DD} = -15 V,		46		
Turn-Off Delay Time	t _{d(OFF)}		$I_D = -200 \text{ mA}, R_G = 2.0 \Omega$		196		
Fall Time	t _f	1			145		

4. Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS (N-CHANNEL)



TYPICAL CHARACTERISTICS (N-CHANNEL)



0.6

0.8

1

0.4

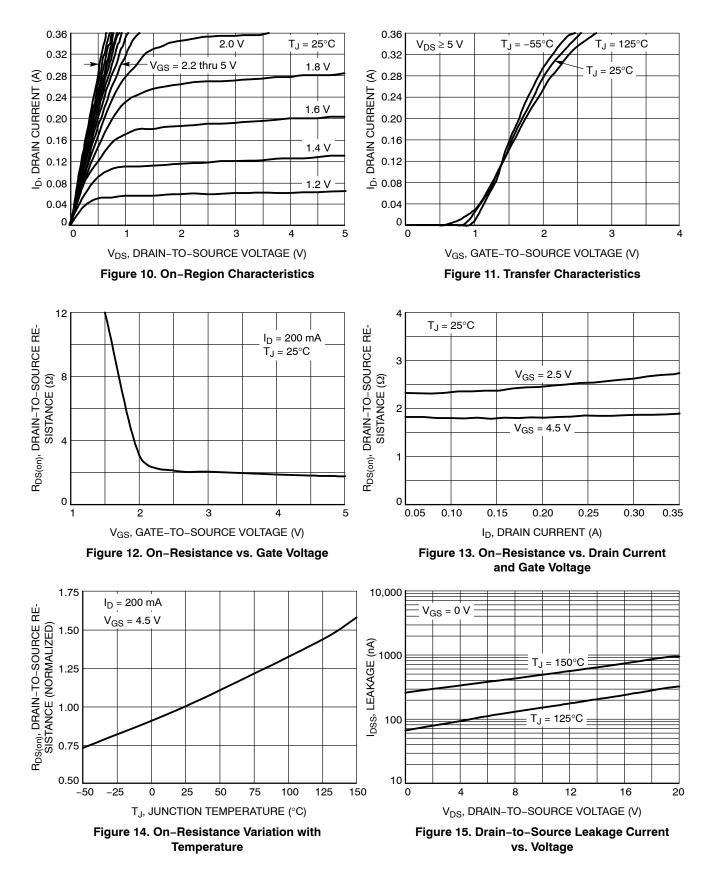
V_{SD}, SOURCE-TO-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

0

0

0.2

TYPICAL CHARACTERISTICS (P-CHANNEL)



TYPICAL CHARACTERISTICS (P-CHANNEL)

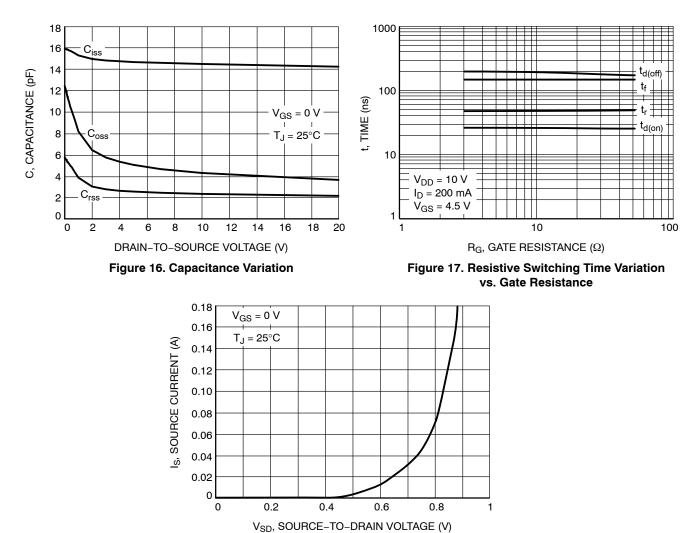
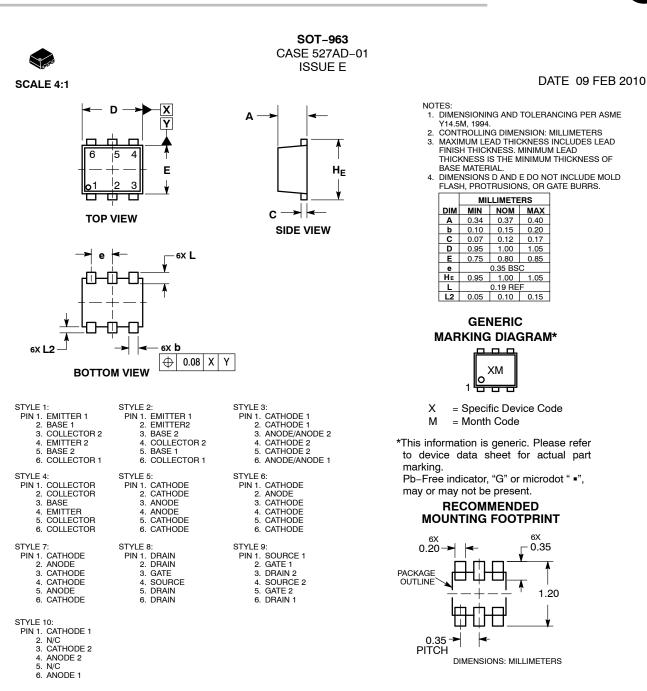


Figure 18. Diode Forward Voltage vs. Current





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